急出货

PD - 94195

International Rectifier

POWER MOSFET THRU-HOLE (TO-257AA)

100V, P-CHANNEL HEXFET® MOSFET TECHNOLOGY

Product Summary

Part Number	RDS(on)	ΙD	Eyelets	
IRFY9130	0.3 Ω	-11.2A	Glass	
IRFY9130M	0.3 Ω	-11.2A	Glass	

HEXFET® MOSFET technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry design achieves very low on-state resistance combined with high transconductance. HEXFET transistors also feature all of the well-established advantages of MOSFETs, such as voltage control, very fast switching, ease of paralleling and electrical parameter temperature stability. They are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and virtually any application where high reliability is required. The HEXFET transistor's totally isolated package eliminates the need for additional isolating material between the device and the heatsink. This improves thermal efficiency and reduces drain capacitance.



Features:

- Simple Drive Requirements
- Ease of Paralleling
- Hermetically Sealed
- Electrically Isolated
- Glass Eyelets
- For Space Level Applications Refer to Ceramic Version Part Numbers IRFY9130C, IRFY9130CM

Absolute Maximum Ratings

	Parameter		Units
ID @ VGS = -10V, TC = 25°C	Continuous Drain Current	-11.2	
ID @ VGS = -10V, TC = 100°C	Continuous Drain Current	-7.1	Α
IDM	Pulsed Drain Current ①	-44	
P _D @ T _C = 25°C	Max. Power Dissipation	75	W
	Linear Derating Factor	0.6	W/°C
VGS	Gate-to-Source Voltage	±20	V
EAS	Single Pulse Avalanche Energy ②	400	mJ
IAR	Avalanche Current ①	-11.2	Α
EAR	Repetitive Avalanche Energy ①	7.5	mJ
dv/dt	Peak Diode Recovery dv/dt ③	-5.5	V/ns
TJ	Operating Junction	-55 to 150	
√ TSTG	Storage Temperature Range		°C
找了PDF	Lead Temperature	300(0.063in./1.6mm from case for 10 sec)	
A SECTION	Weight	3.3 (Typical)	g

For footnotes refer to the last page

Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

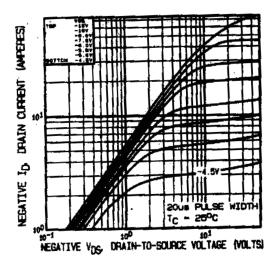
	Parameter	Min	Тур	Max	Units	Test Conditions
BVDSS	Drain-to-Source Breakdown Voltage	-100	_	_	V	$V_{GS} = 0V, I_{D} = -1.0mA$
ΔBVDSS/ΔTJ	Temperature Coefficient of Breakdown Voltage	_	-0.1	_	V/°C	Reference to 25°C, ID = -1.0mA
RDS(on)	Static Drain-to-Source On-State Resistance	_	_	0.30	Ω	VGS = -10V, ID = -7.1A _④
VGS(th)	Gate Threshold Voltage	-2.0	_	-4.0	V	$V_{DS} = V_{GS}$, $I_{D} = -250\mu A$
9fs	Forward Transconductance	2.5	_	_	S (7)	V _{DS} > -15V, I _{DS} = -7.1A ④
IDSS	Zero Gate Voltage Drain Current		_	-25	μΑ	VDS= -80V ,VGS=0V
		_	_	-250	μΑ	VDS = -80V,
						VGS = 0V, TJ = 125°C
IGSS	Gate-to-Source Leakage Forward	_	_	-100	nA	VGS = -20V
IGSS	Gate-to-Source Leakage Reverse		_	100	nA	VGS = 20V
Qg	Total Gate Charge	_	_	30		VGS = -10V, ID = -11.2A
Qgs	Gate-to-Source Charge	_	_	7.1	nC	VDS = -50V
Qgd	Gate-to-Drain ('Miller') Charge		_	2.1		
td(on)	Turn-On Delay Time		_	60		V _{DD} = -50V, I _D = -11.2A,
tr	Rise Time	_	_	140	ns	$RG = 7.5\Omega$
td(off)	Turn-Off Delay Time	_	_	140	115	
tf	Fall Time		_	140		
LS+LD	Total Inductance	_	6.8	_	nΗ	Measured from drain lead (6mm/0.25in. from
						package) to source lead (6mm/0.25in. from package)
Ciss	Input Capacitance	_	800	_		VGS = 0V, VDS = -25V
Coss	Output Capacitance		350	_	pF	f = 1.0MHz
Crss	Reverse Transfer Capacitance	_	125	_		

Source-Drain Diode Ratings and Characteristics

	Parameter		Min	Тур	Max	Units	Test Conditions
Is	Continuous Source Current	(Body Diode)	_	_	-11.2	۸	
ISM	Pulse Source Current (Body	Diode) ①	-	_	-44	Α	
VSD	Diode Forward Voltage		_	_	-4.7	V	$T_j = 25^{\circ}C$, $I_S = -11.2A$, $V_{GS} = 0V$ ④
t _{rr}	Reverse Recovery Time		ı	_	250	nS	$T_j = 25^{\circ}C$, $I_F = -11.2A$, $di/dt \le -100A/\mu s$
QRR	Reverse Recovery Charge		_	_	3.0	μC	V _{DD} ≤ -50V ④
ton	Forward Turn-On Time	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by LS + LD.					

Thermal Resistance

	Parameter	Min	Тур	Max	Units	Test Conditions
RthJC	Junction-to-Case	_	_	1.67		
RthCS	Case-to-sink	_	0.21	_	°C/W	
RthJA	Junction-to-Ambient	_	_	80		Typical socket mount

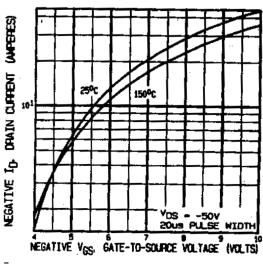


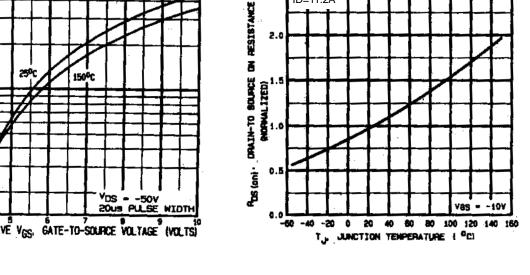
NEGATIVE I_D, DRAIN CUPPENT (AMPERES) PULSE 150°C 10-1 100 100 101 NEGATIVE V_{DS}. DRAIN-70-SOURCE VOLTAGE (VOLTS)

Fig 1. Typical Output Characteristics

Fig 2. Typical Output Characteristics

ÍD=11.2A

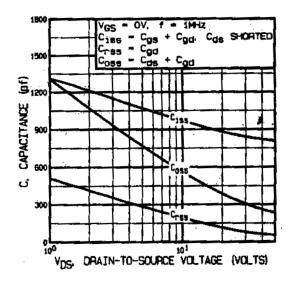




2.0

Fig 3. Typical Transfer Characteristics

Fig 4. Normalized On-Resistance Vs. Temperature



DE 11.2A

VDS - 80V

VDS - 50V

VDS - 20V

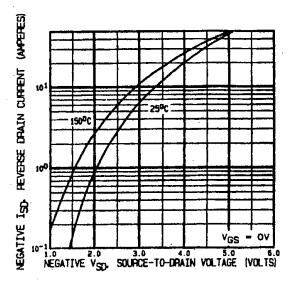
POR TEST CINCUIT

SEE FIRMINE 13.0A d

Gg. TOTAL BATE CHARGE (AC)

Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage



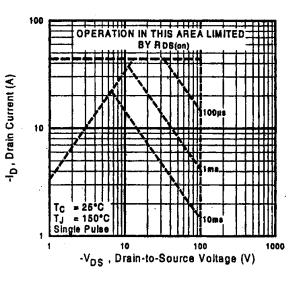


Fig 7. Typical Source-Drain Diode Forward Voltage

Fig 8. Maximum Safe Operating Area

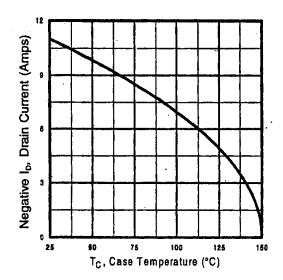


Fig 9. Maximum Drain Current Vs. Case Temperature

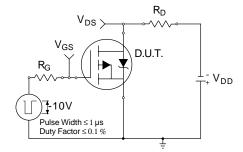


Fig 10a. Switching Time Test Circuit

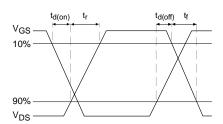


Fig 10b. Switching Time Waveforms

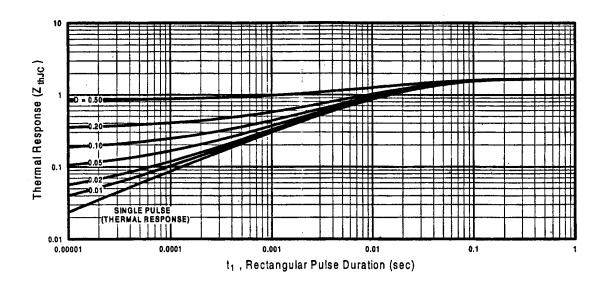


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

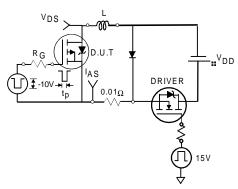


Fig 12a. Unclamped Inductive Test Circuit

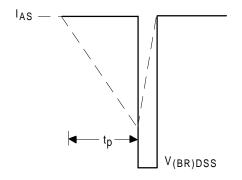


Fig 12b. Unclamped Inductive Waveforms

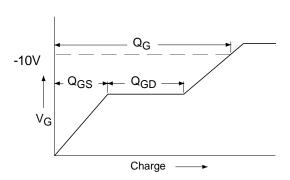


Fig 13a. Basic Gate Charge Waveform

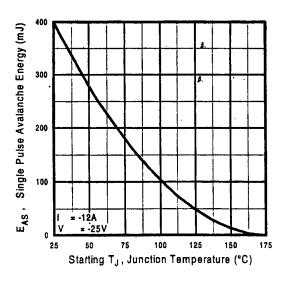


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

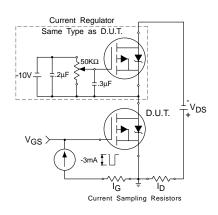
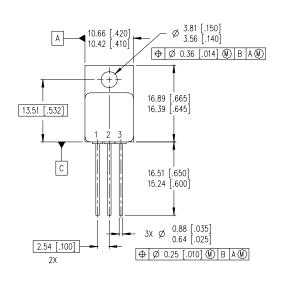


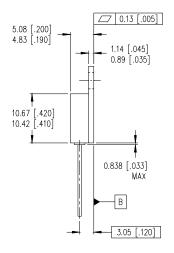
Fig 13b. Gate Charge Test Circuit

Foot Notes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- ② $V_{DD} = -25V$, starting $T_{J} = 25$ °C, L = 6.4mH Peak $I_{L} = -11.2$ A, $V_{GS} = -10V$
- $\label{eq:sphere:sphere:eq:sphere:$
- 4 Pulse width $\leq 300 \ \mu s$; Duty Cycle $\leq 2\%$

Case Outline and Dimensions — TO-257AA



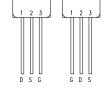


NOTES:

- 1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1994.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE TO-257AA.

<u>LEGEND</u>
D - DRAIN
S - SOURCE

G - GATE



GLASS EYELETS

International Rectifier

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